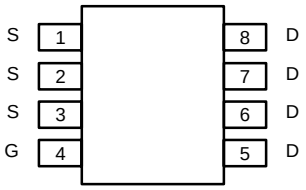
N-Channel 30-V (D-S) MOSFET

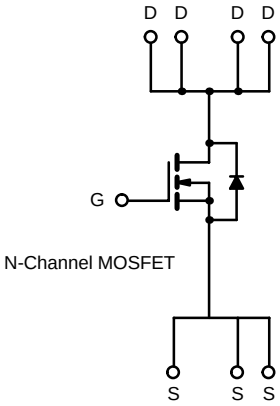
PRODUCT SUMMARY		
V_{DS} (V)	$r_{DS(on)}$ (Ω)	I_D (A)
30	0.012 @ V_{GS} = 10 V	12.4
	0.020 @ V_{GS} = 4.5 V	9.6

TrenchFET® Power MOSFETs
High-Efficiency PWM Optimized
100% R_G Tested

SO-8



Top View



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C UNLESS OTHERWISE NOTED)					
Parameter		Symbol	10 secs	Steady State	Unit
Drain-Source Voltage		V_{DS}	30		V
Gate-Source Voltage		V_{GS}	±20		
Continuous Drain Current (T_J = 150°C)[a]	T_A = 25°C	I_D	12.4	8.8	A
	T_A = 70°C		9.9	7.0	
Pulsed Drain Current		I_{DM}	±50		
Continuous Source Current (Diode Conduction)[a]		I_S	2.60	1.3	
Maximum Power Dissipation[a]	T_A = 25°C	P_D	3.1	1.6	W
	T_A = 70°C		2.0	1.0	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	-55 to 150		°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient (MOSFET)[a]	t ≤ 10 sec	R_{thJA}	34	40	°C/W
	Steady State		70	80	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	17	20	

Notes
a. Surface Mounted on 1" x 1" FR4 Board.

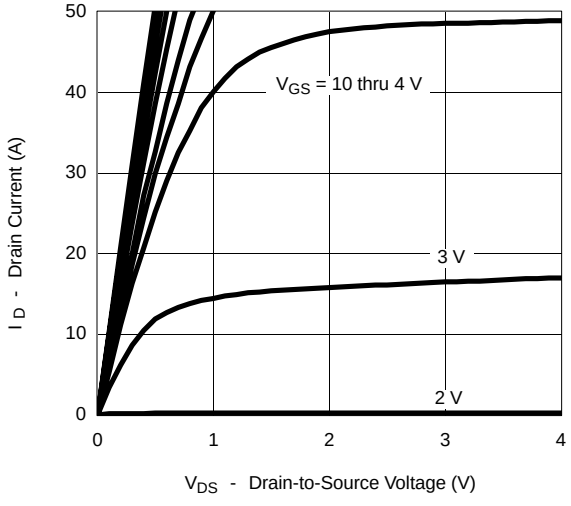
MOSFET SPECIFICATIONS (T_J = 25°C UNLESS OTHERWISE NOTED)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250 μA	0.80			V
Gate-Body Leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = ±20 V			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 24 V, V_{GS} = 0 V			1	μA
		V_{DS} = 24 V, V_{GS} = 0 V, T_J = 70°C			5	
On-State Drain Current[a]	$I_{D(on)}$	V_{DS} ≥ 5 V, V_{GS} = 10 V	50			A
Drain-Source On-State Resistance[a]	$r_{DS(on)}$	V_{GS} = 10 V, I_D = 12.4 A		0.010	0.012	Ω
		V_{GS} = 4.5 V, I_D = 9.6 A		0.016	0.020	
Forward Transconductance[a]	g_{fs}	V_{DS} = 15 V, I_D = 12.4 A		27		S
Diode Forward Voltage[a]	V_{SD}	I_S = 2.6 A, V_{GS} = 0 V		0.75	1.2	V
Dynamic[b]						
Total Gate Charge	Q_g	V_{DS} = 15 V, V_{GS} = 5.0 V, I_D = 12.4 A		8.7	10.5	nC
Gate-Source Charge	Q_{gs}			2.4		
Gate-Drain Charge	Q_{gd}			3.5		
Gate Resistance	R_G		0.1	1.1	1.9	Ω
Turn-On Delay Time	$t_{d(on)}$	V_{DD} = 15 V, R_L = 15 Ω I_D ≅ 1 A, V_{GEN} = 10 V, R_G = 6 Ω		10	20	ns
Rise Time	t_r			11	20	
Turn-Off Delay Time	$t_{d(off)}$			24	50	
Fall Time	t_f			10	20	
Source-Drain Reverse Recovery Time	t_{rr}	I_F = 2.6 A, di/dt = 100 A/μs		50	75	

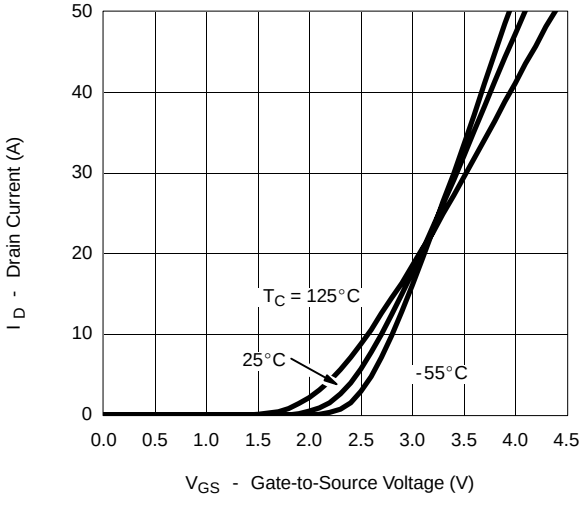
Notes
a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.
b. Guaranteed by design, not subject to production testing.

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

Output Characteristics

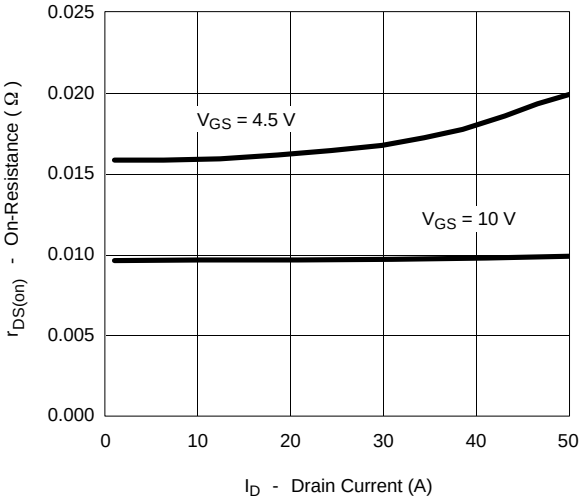


Transfer Characteristics

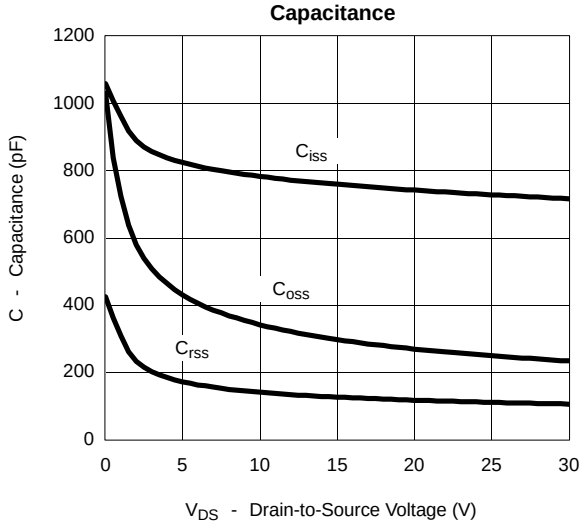


TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

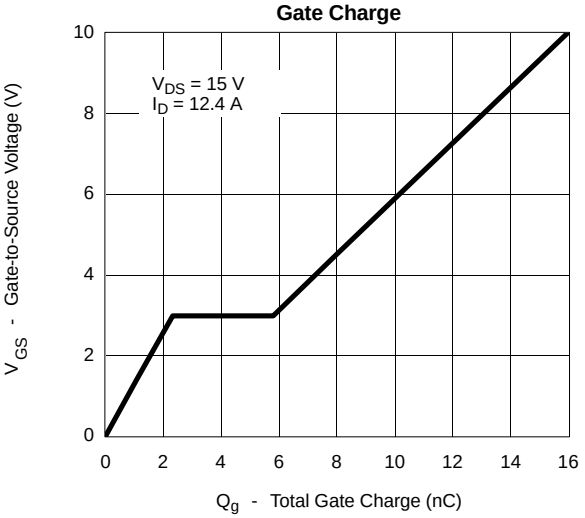
On-Resistance vs. Drain Current



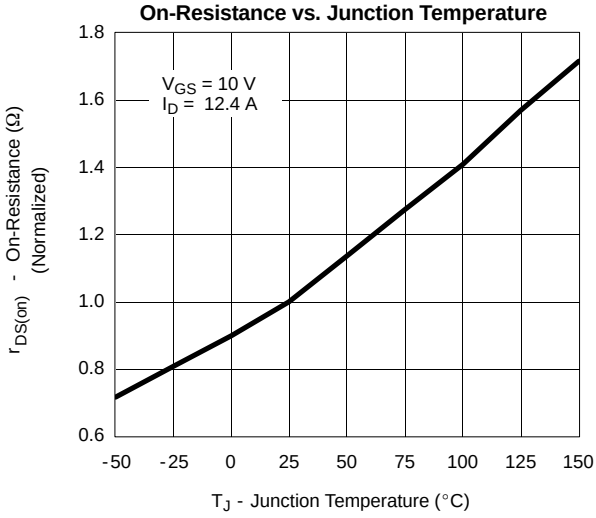
Capacitance



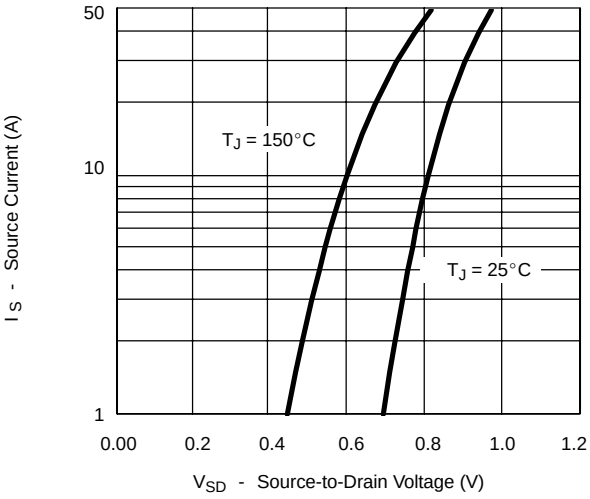
Gate Charge



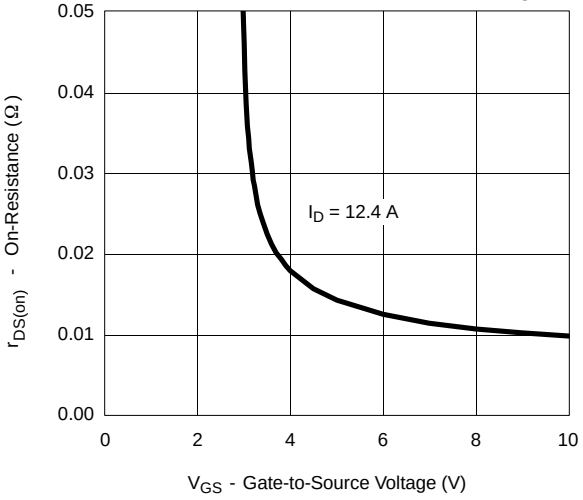
On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage

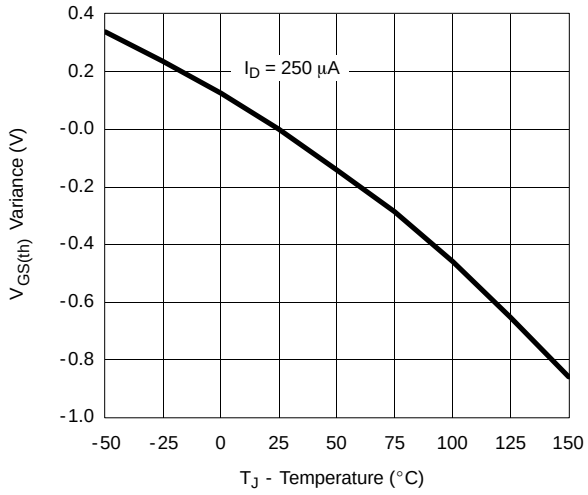


On-Resistance vs. Gate-to-Source Voltage

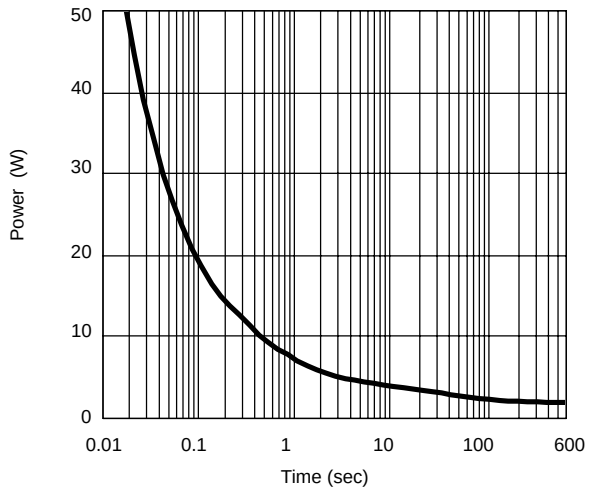


TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

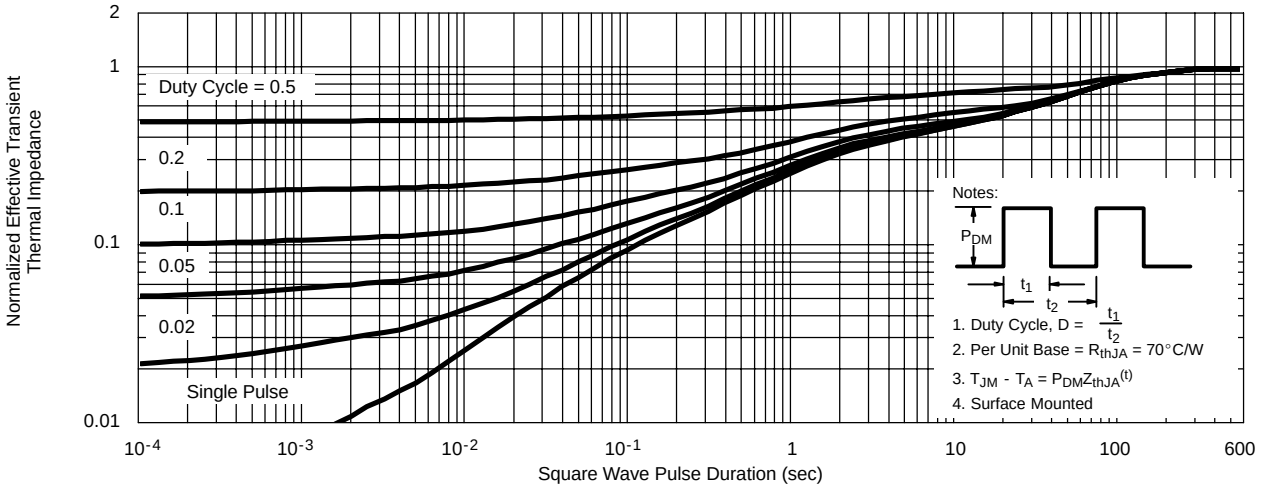
Threshold Voltage



Single Pulse Power



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot